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1. Name of conveying party(ies): (List using letters or numbers for multiple parties)

Tae-Wook Kang

Additional name(s) of conveying party(ies) attached?

() Yes (X) No

2. Name and address of receiving party(ies):

Name: Samsung SDI Co., Ltd.

Address: 575 Shin-dong, Yeongtong-su, Suwon-si, Gyeonggi-do, Republic of Korea

Additional name(s) of receiving party(ies) attached?

() Yes (X) No

3. Nature of conveyance:

- Assignment Security Agreement
- Merger Change of Name
- Other:

Execution Date: (List as in section 1 if multiple signatures)

October 10, 2005

4. US or PCT Application number(s) or US Patent number(s):

Application filed herewith

Additional numbers attached?

() Yes (X) No

5. Party to whom correspondence concerning document should be mailed:

Customer No. 20,995

Address: Knobbe, Martens, Olson & Bear, LLP
2040 Main Street, 14th Floor
Irvine, CA 92614

Return Fax: (949) 760-9502

Attorney's Docket No.: SDISW.005AUS

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h)): \$40

Enclosed

8. Deposit account number: 11-1410

Please charge this account for any additional fees which may be required, or credit any overpayment to this account.

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.

John M. Carson
Name of Person Signing


Signature

10/11/05
Date

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Application No.: Unknown
Filing Date: Herewith

PATENT
Client Code: SDISW.005AUS
Page 1

ASSIGNMENT

WHEREAS, I, the undersigned, have invented certain new and useful improvements in a OLED ENCAPSULATION STRUCTURE AND METHOD OF FABRICATING THE SAME, the specification of which was executed on even date herewith.

AND WHEREAS, Samsung SDI Co., Ltd., (hereinafter "ASSIGNEE"), with its principal place of business at 575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Date: October 10, 2005

Signature: Tae Wook Kang

Name: Tae-Wook Kang

Address: c/o Samsung SDI Co., Ltd.

575 Shin-dong, Yeongtong-gu, Suwon-si

Gyeonggi-do, Republic of Korea

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